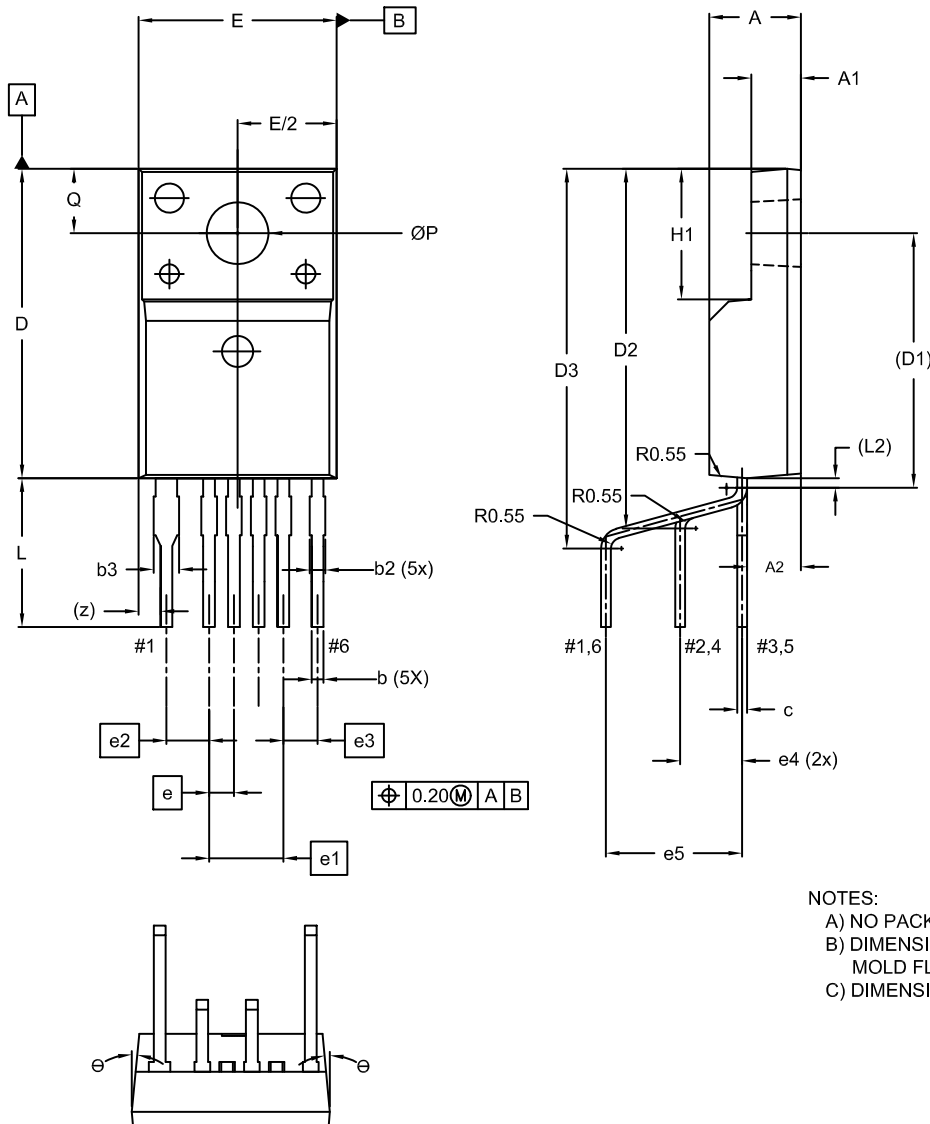


TO-220 FULLPAK 6LD LF
CASE 340BP
ISSUE A

DATE 01 OCT 2021



DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	4.40	4.60	4.80
A1	2.34	2.54	2.74
A2	2.46	2.76	3.06
b	0.50	0.60	0.70
b2	0.70	0.75	0.80
b3	1.20	1.30	1.40
c	0.45	0.53	0.60
D	15.67	15.87	16.07
D1	13.05 REF		
D2	17.94	18.44	18.94
D3	18.97	19.47	19.97
E	9.96	10.16	10.36
E/2	4.98	5.08	5.18
e	1.27 BSC		
e1	3.81 BSC		
e2	2.19 BSC		
e3	1.75 BSC		
e4	2.88	3.18	3.48
e5	6.69	6.99	7.29
H1	6.50	6.70	6.90
L	7.13	7.63	8.13
L2	0.48 REF		
P	3.08	3.18	3.28
Q	3.20	3.30	3.40
z	1.13 REF		
θ	--	--	5°

NOTES:

- A) NO PACKAGE STANDARD APPLIES.
 B) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
 C) DIMENSIONS ARE IN MILLIMETERS.

DOCUMENT NUMBER:	98AON13848G	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	TO-220 FULLPAK 6LD LF	PAGE 1 OF 1

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.